

LTspice Model OpAmp Texas Instruments TLV4314IPWR

Model Information

Model	A macro model		
Call Name	MDC_TLV4314IPWR_LT		
Pin Assign	1:OUT A,2:-IN A,3:+IN A,4:V+,5:+IN B,6:-IN B,7:OUT B, 8:OUT C,9:-IN C,10:+IN C,11:V-,12:+IN D,13:-IN D,14:OUT D		
File List	Model Library MDC_TLV4314IPWR_LTlib		
	Model Report MDC_TLV4314IPWR_LT.pdf(this file)		
Verified Simul	ator Version LTspice 17.1.15		

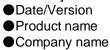
Verified Simulator Version

Note

References

The information which was used for modeling is as follow:

[Data Sheet]



SBOS754A - MARCH 2016-REVISED MARCH 2016 TLVx314 Texas Instruments Incorporated.

[Characteristics listed]

Characteristics

Open Loop Gain, Phase Quiescent Current(per Ch) Offset Voltage Small-Signal Pulse Response EMIRR(Reference Only)

Simulation Condition

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Condition	Unit
Temperature	25	deg C



O:Implemented

× : Not Implemented

Model Functions Table	RANK=1	— : Not applicable
Functions	RANK	Implemented
Open Loop Gain	1	0
Unity Frequency	1	0
Phase Margin	1	0
Input Offset Voltage	1	0
Input Offset Current	1	0
Bias Current	1	—
Maximum output amplitude voltage	1	0
Slew Rate	1	0
Equivalent Input Noise Voltage	2	×
Equivalent Input Noise Current	2	×

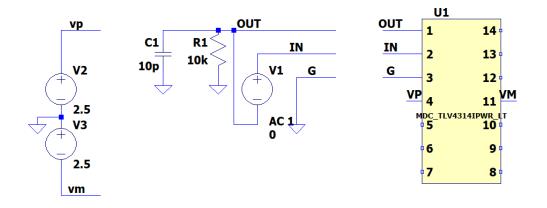


Open Loop Gain, Phase Testbench

Referred to Data Sheet

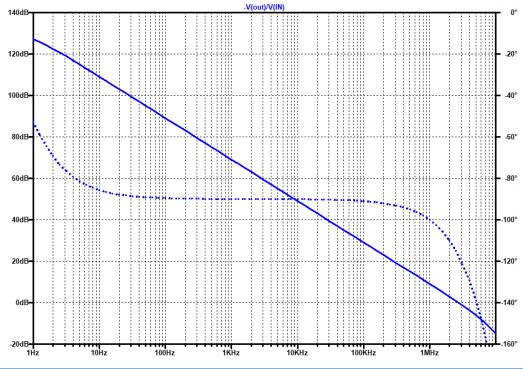
.OPTION TNOM=25 .TEMP 25

.ac dec 10 1 10Meg



Simulation results are following. Explanatory notes -: simulated

Open Loop Gain, Phase



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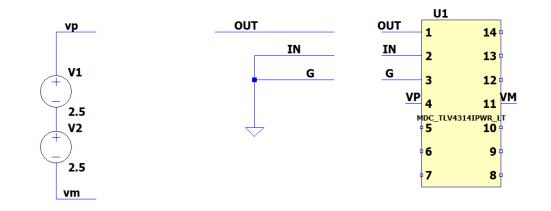


Quiescent Current(per Ch) Testbench

Referred to Data Sheet

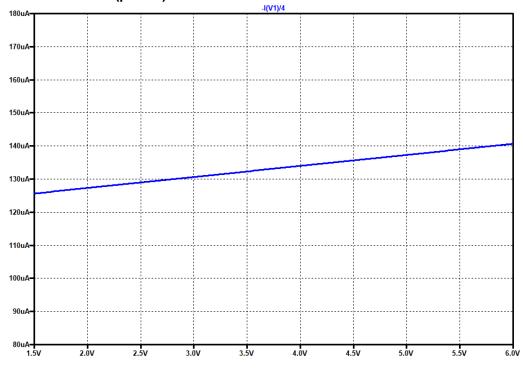
.OPTION TNOM=25 .TEMP 25

.dc V1 1.5 6 0.1



Simulation results are following. Explanatory notes -: simulated

Quiescent Current(per Ch)



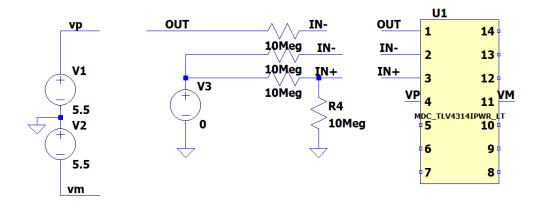


Offset Voltage Testbench

Referred to Data Sheet

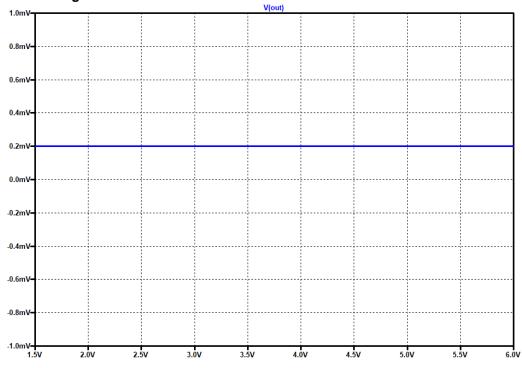
.OPTION TNOM=25 .TEMP 25

.dc V3 1.5 6 0.1



Simulation results are following. Explanatory notes -: simulated

Offset Voltage





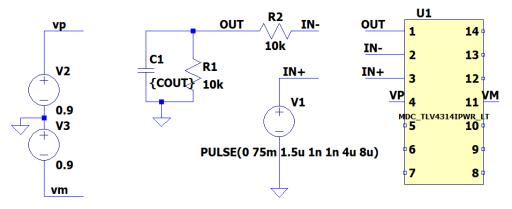
Small-Signal Pulse Response Testbench

Referred to Data Sheet

.OPTION TNOM=25 .TEMP 25

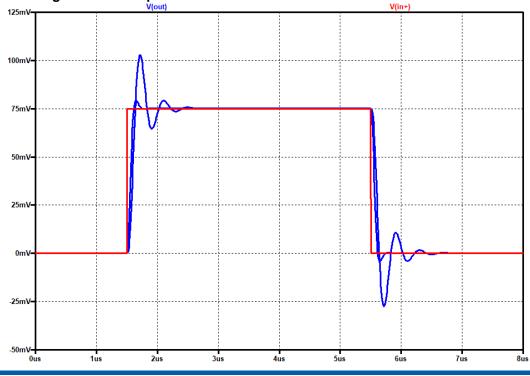
.tran 0 8u 0

.step param COUT list 10p 100p



Simulation results are following. Explanatory notes -: simulated





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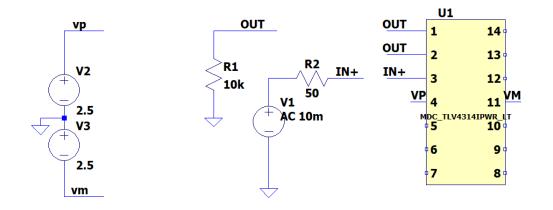


EMIRR Testbench

Referred to Data Sheet

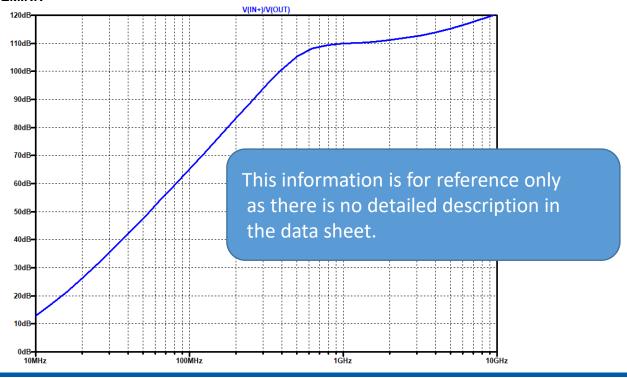
.OPTION TNOM=25 .TEMP 25

.ac dec 10 10Meg 10G



Simulation results are following. Explanatory notes — : simulated

EMIRR



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